OptiPlex Tower 7010

Technical Guidebook



Notes, cautions, and warnings

(i) NOTE: A NOTE indicates important information that helps you make better use of your product.

CAUTION: A CAUTION indicates either potential damage to hardware or loss of data and tells you how to avoid the problem.

WARNING: A WARNING indicates a potential for property damage, personal injury, or death.

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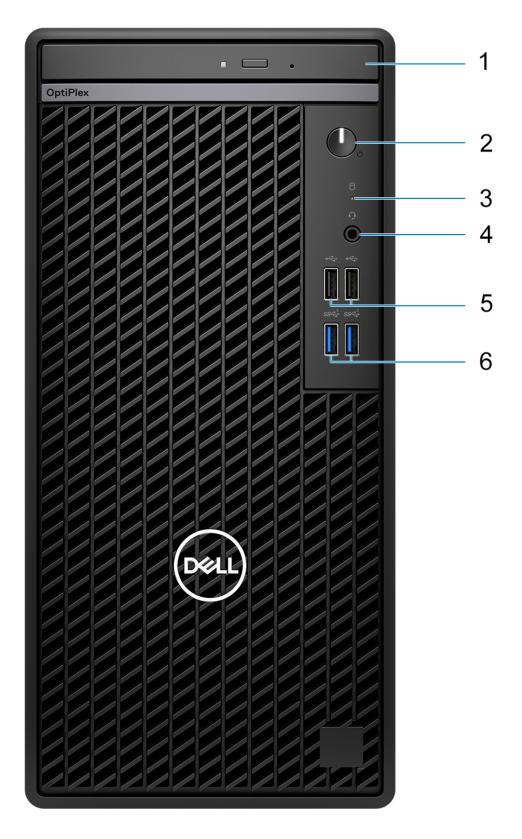
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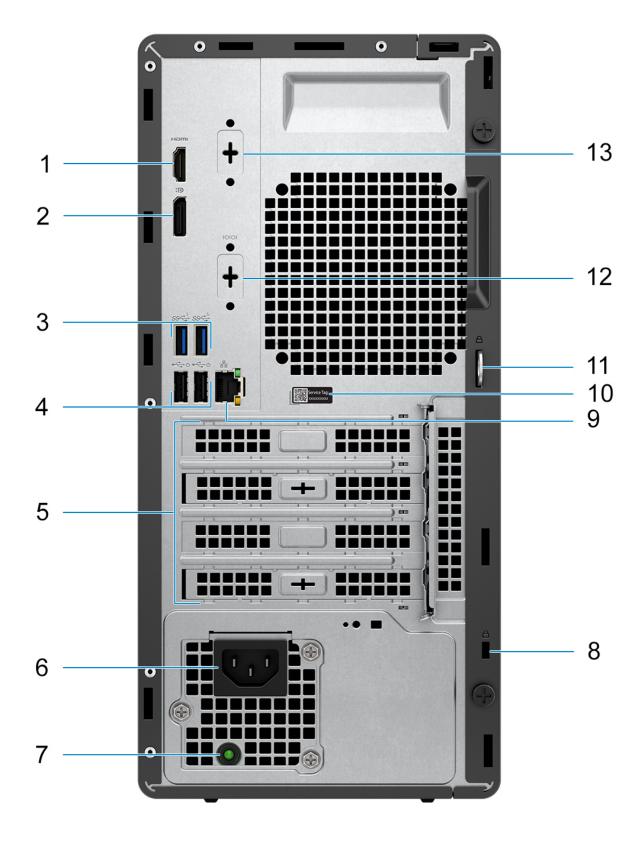
Views of OptiPlex Tower 7010

Front



- 1. Optical disk-drive (optional)
- 2. Power button with diagnostic LED
- **3.** Hard-drive activity light
- 4. Universal audio jack port
- **5.** Two USB 2.0 (480 Mbps) ports
- 6. Two USB 3.2 Gen 1 (5 Gbps) ports

Back



- 1. HDMI 1.4b port
 - i) NOTE: Maximum resolution up to 1920 x 1200 @60Hz
- 2. DisplayPort 1.4a port (HBR2)
 - NOTE: Maximum resolution up to 4096 x 2304 @60Hz
- 3. Two USB 3.2 Gen 1 (5 Gbps) ports
- 4. Two USB 2.0 (480 Mbps) ports with Smart Power On
- **5.** Three expansion card slots
- 6. Power cord connector port
- 7. Power supply diagnostic light
- 8. Security-cable slot (for Kensington locks)
- **9.** RJ45 Ethernet port (10/100/1000 Mbps)
- **10.** Service tag label
- 11. Padlock ring
- 12. Serial port (optional)
- 13. One video port (DisplayPort 1.4a (HBR3)/HDMI 2.1/VGA) (optional)
 - (i) NOTE: Maximum resolution
 - **HDMI 2.1**: up to 4096 x 2160 @60Hz
 - **DisplayPort 1.4a (HBR3)**: up to 5120 x 3200 @60Hz
 - **VGA**: up to 1920 x 1200 @60Hz

Specifications of OptiPlex Tower 7010

Dimensions and weight

The following table lists the height, width, depth, and weight of your OptiPlex Tower 7010.

Table 1. Dimensions and weight

Description	Values		
Height	324.30 mm (12.77 in.)		
Width	154.00 mm (6.06 in.)		
Depth	292.20 mm (11.50 in.)		
Weight i NOTE: The weight of your computer depends on the configuration ordered and manufacturing variability.	 Minimum - 5.32 kg (11.72 lb) Maximum - 6.52 kg (14.38 lb) 		

Processor

The following table lists the details of the processors that are supported by your OptiPlex Tower 7010.

Table 2. Processor

Description	Option one	Option two	Option three	Option four	Option five	Option six	Option seven	Option eight
Processor type	13 th Generation Intel Core i3-13100	13 th Generation Intel Core i5-13400	13 th Generation Intel Core i5-13500	13 th Generation Intel Core i5-13600	Intel Celeron G 6900	Intel Pentium G 7400	12 th Generation Intel Core i3-12100	12 th Generation Intel Core i5-12500
Processor wattage	60 W	65 W	65 W	65 W	46 W	46 W	60 W	65 W
Processor total core count	4	10	14	14	2	2	4	6
Performance -cores	4	6	6	6	2	2	4	6
Efficient- cores	0	4	8	8	0	0	0	0
Processor total thread counts	8	16	20	20	2	4	8	12
i NOTE: Intel® Hyper- Threadin g Technolo gy is only available on Perform ance- cores.								
Processor speed	3.40 GHz to 4.50 GHz	2.50 GHz to 4.60 GHz	2.50 GHz to 4.80 GHz	2.70 GHz to 5.00 GHz	up to 3.40 GHz	up to 3.70 GHz	up to 4.30 GHz	up to 4.60 GHz
Performance-	cores frequenc	У						
Processor base frequency	3.40 GHz	2.50 GHz	2.50 GHz	2.70 GHz	3.40 GHz	3.70 GHz	3.30 GHz	3.00 GHz
Maximum turbo frequency	4.50 GHz	4.60 GHz	4.80 GHz	5.00 GHz	N/A	N/A	4.30 GHz	4.60 GHz
Efficient-core	s frequency							
Processor base frequency	N/A	1.80 GHz	1.80 GHz	2.00 GHz	N/A	N/A	N/A	N/A
Maximum turbo frequency	N/A	3.30 GHz	3.50 GHz	3.70 GHz	N/A	N/A	N/A	N/A
Processor cache	12 MB	20 MB	24 MB	24 MB	4 MB	6 MB	12 MB	18 MB

Table 2. Processor (continued)

Description	Option one	Option two	Option three	Option four	Option five	Option six	Option seven	Option eight
Integrated graphics	Intel UHD Graphics 730	Intel UHD Graphics 730		Intel UHD Graphics 770	Intel UHD Graphics 710	Intel UHD Graphics 710	Intel UHD Graphics 730	Intel UHD Graphics 770

Chipset

The following table lists the details of the chipset supported by your OptiPlex Tower 7010.

Table 3. Chipset

Description	Values
Chipset	Intel Q670
Processor	 13th Generation Intel Core i3/i5 Intel Pentium Gold Intel Celeron
DRAM bus width	64-bit
Flash EPROM	32 MB RPMC+16 MB nRPMC
PCle bus	Up to Gen3

Operating system

Your OptiPlex Tower 7010 supports the following operating systems:

- Windows 11 Home
- Windows 11 Pro
- Windows 11 Pro Downgrade (Windows 10 image)
- Windows 11 Pro National Education
- Windows 10 CMIT Government Edition (China only)
- Ubuntu Linux 22.04 LTS

Memory

The following table lists the memory specifications of your OptiPlex Tower 7010.

Table 4. Memory specifications

Description	Values
Memory slots	Two-UDIMM slots
Memory type	DDR4
Memory speed	• 3200 MT/s
Maximum memory configuration	64 GB
Minimum memory configuration	4 GB

Table 4. Memory specifications (continued)

Description	Values
Memory size per slot	4 GB, 8 GB, 16 GB, and 32 GB
Memory configurations supported	 4 GB, 1 x 4 GB, DDR4, 3200 MT/s, single-channel 8 GB, 1 x 8 GB, DDR4, 3200 MT/s, single-channel 8 GB, 2 x 4 GB, DDR4, 3200 MT/s, dual-channel 16 GB, 1 x 16 GB, DDR4, 3200 MT/s, single-channel 16 GB, 2 x 8 GB, DDR4, 3200 MT/s, dual-channel 32 GB, 1 x 32 GB, DDR4, 3200 MT/s, single-channel 32 GB, 2 x 16 GB, DDR4, 3200 MT/s, dual-channel 64 GB, 2 x 32 GB, DDR4, 3200 MT/s, dual-channel

Memory matrix

The following table lists the memory configurations supported on your OptiPlex Tower 7010.

Table 5. Memory matrix

Configuration	Slot		
	UDIMM1	UDIMM2	
4 GB DDR4	4 GB	NA	
8 GB DDR4	8 GB	NA	
8 GB DDR4	4 GB	4 GB	
16 GB DDR4	16 GB	NA	
16 GB DDR4	8 GB	8 GB	
32 GB DDR4	32 GB	NA	
32 GB DDR4	16 GB	16 GB	
64 GB DDR4	32 GB	32 GB	

External ports

The following table lists the external ports of your OptiPlex Tower 7010.

Table 6. External ports

Description	Values
Network port	 One RJ45 Ethernet port, 1 GHz One RJ45 Ethernet port, 2.5 GHz (optional)
USB ports	Front: Two USB 2.0 (480 Mbps) ports Two USB 3.2 Gen 1 (5 Gbps) ports Rear: Two USB 2.0 (480 Mbps) ports with Smart Power On Two USB 3.2 Gen 1 (5 Gbps) ports
Audio port	Universal audio jack (Front)
Video port	One DisplayPort 1.4a (HBR2)

Table 6. External ports (continued)

Description	Values
	i NOTE: Maximum resolution up to 4096 x 2304 @60Hz One HDMI 1.4b port i NOTE: Maximum resolution up to 1920 x 1200 @60Hz One Optional video port (/Displayport 1.4a port (HBR3)/HDMI 2.1/VGA) i NOTE: Maximum resolution HDMI 2.1: Up to 4096 x 2160 @60Hz DisplayPort 1.4a (HBR3): Up to 5120 x 3200 @60Hz VGA: Up to 1920 x 1200 @60Hz i NOTE: Download and install the latest Intel Graphics driver from www.dell.com/support to enable multiple displays.
I/O port	One Serial port (optional)
Media-card reader	N/A
Power-adapter port	N/A
Security-cable slot	One security-cable slot (for Kensington locks)

Internal slots

The following table lists the internal slots of your OptiPlex Tower 7010.

Table 7. Internal slots

Description	Values
Expansion	1 Full-height Gen 3 PCle x16 slot2 Full-height Gen 3 PCle x1 slot
SATA	3 SATA slots for 2.5-inch/3.5-inch hard-drive and slim optical drive
M.2	 One M.2 2230 slot for WiFi and Bluetooth card One M.2 2230/2280 slots for solid state drives NOTE: To learn more about the features of different types of M.2 cards, search in the Knowledge Base
	Resource at www.dell.com/support.

Ethernet

The following table lists the wired Ethernet Local Area Network (LAN) specifications of your OptiPlex Tower 7010.

Table 8. Ethernet specifications

Description	Values
Model number	Realtek 8111HD
Transfer rate	10/100/1000 Mbps

Wireless module

The following table lists the Wireless Local Area Network (WLAN) module specifications of your OptiPlex Tower 7010.

Table 9. Wireless module specifications

Description	Option one	Option two	Option three
Model number	Intel AX211 (i) NOTE: Intel AX211 is always tied with External SMA antenna.	Realtek RTL8852BE	Realtek RTL8821CE
Transfer rate	2400 Mbps	1201 Mbps	Up to 433 Mbps
Frequency bands supported	2.40 GHz/5 GHz/6 GHz (i) NOTE: The 6 GHz frequency is supported on computers that are installed with Windows 11 operating system only.	2.40 GHz/5 GHz	2.4 GHz/5 GHz
Wireless standards	 WiFi 802.11a /b/g Wi-Fi 4 (WiFi 802.11n) Wi-Fi 5 (WiFi 802.11ac) Wi-Fi 6E (WiFi 802.11ax) 	 WiFi 802.11a /b/g Wi-Fi 4 (WiFi 802.11n) Wi-Fi 5 (WiFi 802.11ac) Wi-Fi 6 (WiFi 802.11ax) 	 WiFi 802.11a /b/g Wi-Fi 4 (WiFi 802.11n) Wi-Fi 5 (WiFi 802.11ac)
Encryption	64-bit/128-bit WEPAES-COMPTKIP	64-bit/128-bit WEPAES-CCMPTKIP	64-bit/128-bit WEPAES-CCMPTKIP
Bluetooth wireless card	Bluetooth wireless card	Bluetooth wireless card	Bluetooth wireless card
	(i) NOTE: The version of the Bluetooth wireless card may vary depending on the operating system that is installed on your computer.		

Audio

The following table lists the audio specifications of your OptiPlex Tower 7010.

Table 10. Audio specifications

Description	Values	
Audio type	High Definition Audio	
Audio controller	Realtek ALC3246-CG	
Internal audio interface	Intel HDA (high-definition audio)	
External audio interface	Universal audio jackOne Line-out audio port with re-tasking to Line-in (rear)	

Storage

This section lists the storage options on your OptiPlex Tower 7010.

Table 11. Storage Matrix

Storage	1st 2.5-inch hard drive	2nd 2.5- inch hard drive	Single 3.5- inch hard drive	Single M.2 socket
2.5-inch hard drive	Yes	No	No	No
Dual 2.5-inch hard drive	Yes	Yes	No	No
3.5-inch hard drive	No	No	Yes	No
2.5-inch hard drive + 3.5-inch hard drive	Yes	No	Yes	No
3.5-inch hard drive + 2.5-inch hard drive	No	Yes	Yes	No
M.2 solid state drive + 3.5-inch hard drive	No	No	Yes	Yes
M.2 solid state drive + 2.5-inch hard drive	No	Yes	No	Yes
M.2 solid state drive + Dual 2.5-inch hard drive	Yes	Yes	No	Yes
M.2 16 GB/32 GB + 2.5-inch hard drive	Yes	No	No	Yes
M.2 16 GB/32 GB + Dual 2.5-inch hard drive	Yes	Yes	No	Yes
M.2 16 GB/32 GB + 3.5-inch hard drive	No	No	Yes	Yes
M.2 16 GB/32 GB + 2.5-inch hard drive + 3.5-inch hard drive	Yes	No	Yes	Yes
M.2 16 GB/32 GB + 3.5-inch hard drive + 2.5-inch hard drive	No	Yes	Yes	Yes
M.2 solid state drive	No	No	No	Yes

Table 12. Storage specifications

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Storage type	Interface type	Capacity	
2.5-inch, 7200 RPM, hard-disk drive	SATA 3.0	Up to 1 TB	
3.5-inch, 7200 RPM, hard-disk drive	SATA 3.0	Up to 2 TB	
M.2 2230 solid state drive	PCIe NVMe, Class 25	Up to 2 TB	
M.2 2230 solid state drive	PCIe NVMe, Class 35	Up to 1 TB	
M.2 2230 Opal Self-Encrypting solid state drive	PCIe NVMe, Class 35	256 GB	
M.2 2280 solid state drive	PCIe NVMe, Class 40	Up to 1 TB	
M.2 2280 Opal Self-Encrypting solid state drive	PCIe NVMe, Class 40	Up to 1 TB	

Power ratings

The following table lists the power rating specifications of OptiPlex Tower 7010.

Table 13. Power ratings

Desc	ription	Option one	Option two
Туре		180 W internal power supply unit (PSU), 85% Efficient, 80 Plus Bronze	300 W internal power supply unit (PSU), 92% Efficient, 80 Plus Platinum
Input	voltage	90 VAC-264 VAC	90 VAC-264 VAC
Input	frequency	47 Hz-63 Hz	47 Hz-63 Hz
Input current (maximum)		3.0 A	4.2 A
Outp	ut current (continuous)	 12 VA/15 A 12 VB/14 A Standby mode: 12 VA/1.5 A 12 VB/3.3 A 	 12 VA/18 A 12 VB/18 A Standby mode: 12 VA/1.5 A 12 VB/3.3 A
Rate	d output voltage	• +12 VA • +12 VB	+12 VA+12 VB
Temp	perature range:		
	Operating	5°C-45°C (41°F-113°F)	5°C-45°C (41°F-113°F)
	Storage	-40°C-70°C (-40°F-158°F)	-40°C-70°C (-40°F-158°F)

Power supply connector

The following table lists the Power supply connector specifications of your OptiPlex Tower 7010.

Table 14. Power supply connector

Power supply unit	Power supply connectors	
180 W (80 PLUS Bronze)	Two 4 pin connectors for processorOne 8 pin connector for system board	
300 W (80 PLUS Platinum)	Two 4 pin connectors for processorOne 8 pin connector for system board	

GPU—Integrated

The following table lists the specifications of the integrated Graphics Processing Unit (GPU) supported by your OptiPlex Tower 7010.

Table 15. GPU—Integrated

Controller	External display support	Memory size	Processor
Intel UHD Graphics 710	 One DisplayPort 1.4a port (HBR2) One HDMI 1.4b port (1920x1200@60Hz max. resolution) 	Shared system memory	Intel Pentium G7400/ Intel Celeron G6900 processors

Table 15. GPU—Integrated (continued)

Controller	External display support	Memory size	Processor
Intel UHD Graphics 730	 One DisplayPort 1.4a port (HBR2) One HDMI 1.4b port (1920x1200@60Hz max. resolution) 	Shared system memory	 13th Generation Intel Core i3-13100 and i5-13400 processors 12th Generation Intel Core i3-12100 processor
Intel UHD Graphics 770	 One DisplayPort 1.4a port (HBR2) One HDMI 1.4b port (1920x1200@60Hz max. resolution) 	TBD	 13th Generation Intel Core i5-13500 and i5-13600 processors 12th Generation Intel Core i3-12500 processor

Video port resolution (GPU—Integrated)

Table 16. Video port resolution (GPU—Integrated)

Graphics card	Video ports	Maximum supported resolution
Intel UHD Graphics	 One HDMI 1.4b port One DisplayPort 1.4a port (HBR2) One Optional video port (DisplayPort 1.4a (HBR3)/HDMI 2.1/VGA) 	 HDMI 1.4b port - 1920 x 1200 @ 60 Hz DisplayPort 1.4a port - 4096 x 2304 @ 60 Hz One Optional video port - HDMI 2.1: up to 4096 x 2160 @60Hz DisplayPort 1.4a (HBR3): up to 5120 x 3200 @60Hz VGA: up to 1920 x 1200 @60Hz

External display support (GPU—Integrated)

Display support for the integrated graphics card

Table 17. Display support specifications

Graphics card	Supported external displays
Intel UHD Graphics 710/730/770	3
Intel UHD Graphics 710/730/770 + optional module	4

GPU—Discrete

The following table lists the specifications of the discrete Graphics Processing Unit (GPU) supported by your OptiPlex Tower 7010.

Table 18. GPU—Discrete

Controller	External display support	Memory size	Memory type
AMD Radeon RX6300	Two DisplayPort 1.4 ports	2 GB	GDDR6
AMD Radeon RX6500	Two DisplayPort 1.4 ports	4 GB	GDDR6

Video port resolution

The following table lists the video port resolution for your OptiPlex Tower 7010.

Table 19. Video port resolution

Graphics card	Video ports	Maximum supported resolution
AMD Radeon RX6300	• 2 DisplayPort 1.4a ports	8K 120 Hz, 8K @60 Hz is the maximum resolution for one port configuration.
AMD Radeon RX6300	2 DisplayPort 1.4a ports	8K 120 Hz, 8K @60 Hz is the maximum resolution for one port configuration.

External display support (GPU—Discrete)

Table 20. External display support (GPU—Discrete)

Graphics Card	Video ports	Number of supported external displays	DisplayPort Multi-Stream Transport (MST) support
AMD Radeon RX6300	Two DisplayPort 1.4a ports	2	Supported
AMD Radeon RX6500	Two DisplayPort 1.4a ports	2	Supported

NOTE: DisplayPort Multi-Stream Transport (MST) allows you to daisy chain monitors that have DisplayPort 1.2 and above ports and MST support. For more information about using DisplayPort Multi-Stream Transport, see www.dell.com/support.

Hardware security

The following table lists the hardware security of your OptiPlex Tower 7010.

Table 21. Hardware security

Hardware security
Kensington security-cable slot
Padlock ring
Chassis lock slot support
Chassis intrusion switch
Lockable cable covers
Supply chain tamper alerts
SafeID including Trusted Platform Module (TPM) 2.0
Smart card keyboard (FIPS)
Microsoft Windows Device Guard and Credential Guard (Enterprise SKU)
Microsoft Windows Bitlocker
Local hard drive data wipe through BIOS (Secure Erase)

Table 21. Hardware security (continued)

Hardware security
Self-encrypting storage drives (Opal, FIPS)
Trusted Platform Module TPM 2.0
China TPM
Intel Secure Boot
Intel Authenticate
SafeBIOS: includes Dell Off-host BIOS Verification, BIOS Resilience, BIOS Recovery, and additional BIOS Controls

Environmental

The following table lists the environmental specifications of your OptiPlex Tower 7010.

Table 22. Environmental

Feature	Values
Recyclable packaging	Yes
BFR/PVC—free	No
Vertical orientation packaging support	No
Multi-Pack packaging	Yes (optional)
Energy-Efficient Power Supply	Standard
ENV0424 compliant	Yes

NOTE: Wood-based fiber packaging contains a minimum of 35% recycled content by total weight of wood-based fiber. Packaging that contains without wood-based fiber can be claimed as Not Applicable. The anticipated required criteria for EPEAT 2018.

Regulatory compliance

The following table lists the regulatory compliance of your OptiPlex Tower 7010.

Table 23. Regulatory compliance

Regulatory compliance
Product Safety, EMC and Environmental Datasheets
Dell Regulatory Compliance Home page
Dell and the Environment

Operating and storage environment

This table lists the operating and storage specifications of your OptiPlex Tower 7010.

Airborne contaminant level: G1 as defined by ISA-S71.04-1985

Table 24. Computer environment

Description	Operating	Storage
Temperature range	10°C-35°C (50°F-95°F)	-40°C-70°C (-40°F-158°F)
Relative humidity (maximum)	20% to 80% (non-condensing) (non-condensing, Max dew point temperature = 26°C)	0% to 95% (non-condensing) 5% to 95% (non-condensing, Max dew point temperature = 33°C)
Vibration (maximum)*	0.26 GRMS random at 5 Hz-350 Hz	1.37 GRMS random at 5 Hz-350 Hz
Shock (maximum)	Bottom/Right half-sine pulse 40G, 2 ms	105G, 2 ms half-sine pulse
Altitude range	-15.2 m to 3048 m (-49.8 ft to 10,000 ft)	-15.2 m to 10,668 m (-49.8 ft to 35,000 ft)

CAUTION: Operating and storage temperature ranges may differ among components, so operating or storing the device outside these ranges may impact the performance of specific components.

 $[\]ensuremath{^{*}}$ Measured using a random vibration spectrum that simulates user environment.

[†] Measured using a 2 ms half-sine pulse.

Engineering specifications

Physical system dimensions

The following table provides the physical dimensions of your OptiPlex Tower 7010.

NOTE: System weight and shipping weight are based on a typical configuration and may vary based on your system configuration. A typical configuration includes integrated graphics, one hard drive, and one optical drive.

Table 25. Physical system dimensions

Feature	Values	
Chassis volume	14.60 liters	
Chassis Weight	Minimum: 5.32 kg (11.72 lb)Maximum: 6.52 kg (14.38 lb)	
Chassis dimensions		
Height	324.30 mm (12.77 in.)	
Width	154.00 mm (6.06 in.)	
Depth	292.20 mm (11.50 in.)	
Shipping Weight (includes packaging materials)	7.76 kg (17.09 lb)	
Packaging dimensions	·	
Height	338 mm (13.31 in.)	
Width	494 mm (19.44 in.)	
Depth	394 mm (15.50 in.)	

Add-in card dimensions

System board connector maximum add-in card allowable dimensions

Table 26. System board connector maximum add-in card allowable dimensions

Feature	Values
PCIe x16 connector	1
Voltage	3.3 V/12 V
Height	111.15 mm (4.37 in.) Full height
Length	248.92 mm (9.80 in.)
Maximum wattage	50W with 180 W PSU75W with 300 W PSU
PCIe x1 connector	2

Table 26. System board connector maximum add-in card allowable dimensions (continued)

Feature	Values
Voltage	3.3 V/12 V
Height	111.15 mm (4.37 in.) Full height
Length	114.30 mm (4.50 in.)
Maximum wattage	10W

Table 27. M.2 2230 slot for Wi-Fi card

Voltage	3.3 V
Width	22.00 mm (0.86 in.)
Length	30.00 mm (1.18 in.)
Thickness	3.65 mm (0.14 in.)
Maximum wattage	6.6W

Table 28. M.2 2280 slot for solid-state drive

Voltage	3.3 V
Width	22.00 mm (0.86 in.)
Length	80.00 mm (3.14 in.)
Thickness	3.80 mm (0.15 in.)
Maximum Wattage	8.25W

Table 29. M.2 2230 slot for solid-state drive

Voltage	3.3 V
Width	22.00 mm (0.86 in.)
Length	30.00 mm (1.18 in.)
Thickness	2.30 mm (0.09 in.)
Maximum wattage	6.6W

PCIe lane details

Table 30. PCIe lane details

Expansion Slot Type	Voltage	Maximum Height	Maximum Length	Maximum Wattage	Cards supported
PCle x16 connector	3.3 V/12 V	111.15 mm (4.37 in.)	248.92 mm (9.80 in.)	50 W with 180 W PSU75 W with 240 W/300 W PSU	Yes
PCle x1 connector	3.3 V/12 V	111.15 mm (4.37 in.)	114.30 mm (4.50 in.)	10 W	Yes
PCIe x1 connector	3.3 V/12 V	111.15 mm (4.37 in.)	114.30 mm (4.50 in.)	10 W	Yes

Total Add-in-Card power does not exceed 75 W/125 W/150 W depending on PSU option.

Dust filter

The following table lists the dust filter specifications of your OptiPlex Tower 7010.

Table 31. Dust filter

Feature	Values
Туре	0.20 mm (0.008 in.)
Mesh count	2540 mm (100.00 in.)
Weave	PW
Silk diameter	0.05 mm (0.002 in.)
Open area	61 %
Thickness	0.10 mm (0.004 in.)
Remark	PET

PCle add-in cards

Serial port PCle card, Low Profile

Table 32. Serial port PCIe card, Low Profile

Feature	Values
Interface	● RS-232 ● IEEE1284
Data rates	50 bps ~115.2 Kbps (serial)maximum 1.8 Mbps (parallel)
Controller details	
Controller	SUNIX SUN2212 (16C950 UART compatible)
Controller bus architecture	PCI Express 2.0Single-Lane (x1)
Driver support	Windows 10 (64-bit)
Half-height serial add-in dongle	Optional
Environment	
Operating temperature	0°C to 60°C (32°F-140°F)
Operating humidity	5% to 95% RH
Storage temperature	-20°C to 85°C (-4°F to 185°F)

Parallel Port PCIe card, Low Profile

Table 33. Parallel Port PCIe card, Low Profile

Feature	Values
Interface	• RS-232

Table 33. Parallel Port PCle card, Low Profile (continued)

Feature	Values
	• IEEE1284
Data rates	50 bps ~115.2 Kbps (serial)maximum 1.8 Mbps (parallel)
Controller details	
Controller	SUNIX SUN2212 (16C950 UART compatible)
Controller bus architecture	PCI Express 2.0Single-Lane (x1)
Driver support	Windows 10 (64-bit)
Half-height parallel add-in dongle	Optional
Environment	
Operating temperature	0°C to 60°C (32°F-140°F)
Operating humidity	5% to 95% RH
Storage temperature	-20°C to 85°C (-4°F to 185°F)

PS/2 and Serial Port Card, Low Profile

The following table lists the PS/2 and serial port card, low profile specifications.

Table 34. PS/2 and serial port card, low profile specifications

Feature	Values	
Interface	UART	
Data rates	250 kbps / 235 kbps	
Controller details		
Controller	Microchip DEC1515	
Controller bus architecture	PCle	
Driver support	N/A	
Half-height serial add-in dongle	N/A	
Environment		
Operating temperature	0°C to 70°C (32°F to 158°F) / -40°C to 85°C (-40°F to 185°F	
Operating humidity	60% RH	
Storage temperature	-65°C to 150°C (-85°F to 302°F)	

Ethernet

Realtek RTL8111HD

The following table lists the Realtek RTL8111HD specifications.

Table 35. Realtek RTL8111HD specifications

Feature	Values
External connector type	RJ45
Data rate	10/100/1000 Mbps
Controller Details	
Controller bus architecture	PCI Express base specification revision 1.0a
Integrated memory	Yes
Data transfer mode	Yes (Bus-Master DMA)
Power consumption (Full operation per data rate connection speed)	542 mW (Max)
Power consumption (Standby operation)	76 mW (Max)
IEEE standards compliance	802.3
Hardware certifications	N/A
Boot ROM support	EEPROM (Located in SPI)
Network Transfer Mode	
Network transfer rate	10 Mb (full/half-duplex)
10BASE-T (full-duplex) 20 Mbps	100 Mb (full/half-duplex)
100BASE-TX (half-duplex) 100 Mbps	1000 Mb (full-duplex)
Environmental	
Operating temperature range	0°C-70°C (32°F-158°F)
Operating humidity	20% to 80% (non condensing)
Operating system driver Support	Windows 11Windows 10 64-bitUbuntuNeokylin
Manageability	Wakeup On LAN PXE 2.1
Management capabilities alerting	Optional Intel Standard Manageability (must be made at time of purchase).

This term does not connote an actual operating speed of 1 Gb/sec. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Wireless module

Intel AX211, 2x2 MIMO, 2400 Mbps, 2.4/5/6 GHz, Wi-Fi 6E (WiFi 802.11ax), Bluetooth 5.3

The following table lists the Intel AX211 specifications.

i NOTE: Wi-Fi 6 is supported in regions where Wi-Fi 6E is unavailable.

Table 36. Intel AX211 specifications

Description	Specifications	
Host interface	CNVio	
Network standard	IEEE 802.11a/b/g/n/ac/ax, 160 MHz channel use, MU-MIMO, new 6 GHz band	
Wi-Fi Alliance certifications	Wi-Fi CERTIFIED 6, Wi-Fi CERTIFIED a/b/g/n/ac,WMM, WMM-Power Save, WPA2, WPA3, WPS, PMF,Wi-Fi Direct, Wi-Fi Agile Multiband i NOTE: Other names and brands may be claimed as the property of others.	
Operating frequency bands	2.4 GHz5 GHz6 GHz	
Data rate	 2.4 GHz 40M: Up to 574 Mbps 5/6 GHz 80M: Up to 1.2 Gbps 5/6 GHz 160M: Up to 2.4 Gbps 	
Power consumption	Optimized power modes (sleep states) reduce power consumption during periods of inactivity	
Security methods	WPA2 Personal and EnterpriseWPA3	
Authentication protocols	 802.1X EAP-TLS EAP-TTLS/MSCHAPv2 PEAPv0 -MSCHAPv2 (EAP-SIM, EAP-AKA, EAP-AKA) 	
Encryption	 64-bit and 128-bit WEP TKIP 128-bit AES-CCMP 256-bit AES-GCMP 	
Product safety	ULC-ULCB (IEC60950-1)	
Management capabilities alerting	Support for Intel AMT	
Government compliance	FIPS 140-2FISMA	
Client utility	Intel PRO/Set wireless software v22 and later	
Antenna diversity	Supported	
Radio On/Off	Supported	
Roaming	Support seamless roaming between access points	

Table 36. Intel AX211 specifications (continued)

Description	Specifications
Wake on wireless	Supported
Wireless display	Native Miracast support by Windows
Wireless PAN standard	Dual Mode Bluetooth 5.3BLE
Bluetooth data rates	Up to 3 Mbps
Bluetooth operating frequency bands	2.4 GHz
Bluetooth profiles supported	Support for Microsoft Inbox Bluetooth Wireless Card profiles in Windows
Bluetooth data encryption	128-bit encryption
Bluetooth output power	Power class 1
Operating temperature	0°C to + 50°C (Full performance at shield temperatures up to 80°C)
Storage temperature	-40°C to +70°C
Humidity	Up to 90% RH non-condensing (at temperatures of 25°C to 35°C)

Realtek RTL8852BE, 1x1, Wi-Fi 5 (WiFi 802.11ac), Bluetooth 5.3

The following table lists the Realtek RTL8852BE specifications.

Table 37. Realtek RTL8852BE specifications

Description	Values
Host interface	Wi-Fi - PCle Bluetooth - USB
Network standard	IEEE 802.11a/b/g/n/ac, MU-MIMO
Wi-Fi Alliance certifications	 Wi-Fi certified a/b/g/n/ac WMM WPA WPA2 Wi-Fi Direct (Windows only)
Operating frequency bands	2.4 Ghz5 Ghz
Data rate	2.4 GHz 40M: Up to 150 Mbps5 GHz 80M: Up to 433 Mbps
Power consumption	Optimized power modes (sleep states) reduce power consumption during periods of inactivity
Authentication	 Open Shared WPA WPA-PSK WPA2 WPA2-PSK
Client utility	Native Wi-Fi and Bluetooth Microsoft UI support

Table 37. Realtek RTL8852BE specifications (continued)

Description	Values
Software support	Microsoft WHQL certified for WindowsLinux
Radio On/Off	Supported
Roaming	Support seamless roaming between access points
Wake on wireless	Supported
Wireless display	Native Miracast support by Windows
Wireless PAN standard	Dual Mode Bluetooth 5.0BLE
Bluetooth data rates	Up to 3 Mbps
Bluetooth operating frequency bands	2.4 GHz
Bluetooth profiles supported	Support for Microsoft Inbox Bluetooth profiles in Windows
Bluetooth data encryption	128-bit encryption
Operating temperature	0°C to + 70°C
Storage temperature	-40°C to +85°C

Realtek RTL8821CE, 1x1, Wi-Fi 5 (Wi-Fi 802.11ac), Bluetooth 5.0

The following table lists the Realtek RTL8821CE specifications.

Table 38. Realtek RTL8821CE specifications

Host interface	Wi-Fi - PCleBluetooth - USB
Network standard	IEEE 802.11a/b/g/n/ac, MU-MIMO
Wi-Fi Alliance certifications	 Wi-Fi certified a/b/g/n/ac WMM WPA WPA2 Wi-Fi Direct (Windows only)
Operating frequency bands	2.4 GHz5 GHz
Data rate	2.4 GHz 40M: Up to 150 Mbps5 GHz 80M: Up to 433 Mbps
Power consumption	Optimized power modes (sleep states) reduce power consumption during periods of inactivity
Authentication	 Open Shared WPA WPA-PSK WPA2 WPA2-PSK
Client utility	Native Wi-Fi and Bluetooth Microsoft UI support
Software support	Microsoft WHQL certified for Windows Linux

Table 38. Realtek RTL8821CE specifications (continued)

Radio On/Off	Supported
Roaming	Support seamless roaming between access points
Wake on wireless	Supported
Wireless display	Native Miracast support by Windows
Wireless PAN standard	Dual Mode Bluetooth 5.0BLE
Bluetooth data rates	Up to 3 Mbps
Bluetooth operating frequency bands	2.4 GHz
Bluetooth profiles supported	Support for Microsoft Inbox Bluetooth profiles in Windows
Bluetooth data encryption	128-bit encryption
Operating temperature	0°C to + 70°C
Storage temperature	-40°C to +85°C

GPU—Integrated

Intel UHD Graphics 730

Table 39. Intel UHD Graphics 730 specifications

Intel UHD Graphics 730		
Bus Type	Integrated	
Memory type	Shared memory	
Graphics Level	Intel core i3/i5: GT1 (UHD)	
Overlay Planes	Yes	
Operating Systems Graphics/ Video API Support	DirectX 12, OpenGL (4.6)	
Supports maximum resolution	• On board DP1.4a (HBR2)(4096 x 2304 @60 Hz)	
Maximum vertical refresh rate	Up to 60 Hz depending on resolution	
External ports	One Optional video port (HDMI 2.1/Displayport 1.4a (HBR3)/VGA/USB Type-C with DisplayPort Alt mode) (i) NOTE: Maximum resolution • HDMI 2.1: up to 4096 x 2160 @60Hz • DisplayPort 1.4a (HBR3): up to 5120 x 3200 @60Hz • VGA: up to 1920 x 1200 @60Hz	
Multiple display support	Up to 4 displays via DisplayPort Multi-Streaming Technology (MST)	

Intel UHD Graphics 770

Table 40. Intel UHD Graphics 770 specifications

Intel UHD Graphics 770	
Bus Type	Integrated

Table 40. Intel UHD Graphics 770 specifications (continued)

Intel UHD Graphics 770		
Memory type	Shared memory	
Graphics Level	Intel core i5/i7/i9: GT1 (UHD)	
Overlay Planes	Yes	
Operating Systems Graphics/ Video API Support	DirectX 12, OpenGL (4.6)	
Supports maximum resolution	• On board DP1.4a (HBR2)(4096 x 2304 @ 60Hz)	
Maximum vertical refresh rate	Up to 60 Hz depending on resolution	
External ports	One Optional video port (HDMI 2.1/Displayport 1.4a (HBR3)/VGA/USB Type-C with DisplayPort Alt mode) (i) NOTE: Maximum resolution • HDMI 2.1: up to 4096 x 2160 @60Hz • DisplayPort 1.4a (HBR3): up to 5120 x 3200 @60Hz • VGA: up to 1920 x 1200 @60Hz	
Multiple display support	Up to 4 displays via DisplayPort Multi-Streaming Technology (MST)	

GPU—Discrete

AMD Radeon RX6300, 2 GB, GDDR5

The following table lists the AMD Radeon RX6300 specifications.

Table 41. AMD Radeon RX6300 specifications

Feature	Values
Dedicated graphics memory	2 GB, GDDR6
Memory bus	32-bit
Memory config	SAMSUNG: K4ZAF325BM-HC16, DPN: 3PNGNHYNIX: H56G42AS4DX014, DPN MFN30
Width	Single slot
Approximate wattage	TBP: 32 W
Base clock	N/A
Boost clock	N/A
NVIDIA CUDA cores	N/A
G-Sync / Freesync ready	Freesync (AMD Interlock)
Supported APIs	DirectX 12 (AMD Interlock)
Maximum resolution	8K 120Hz, 8K@60Hz is the maximum resolution for one port config.
HDMI support	No
HDCP support	Yes
I/O ports	2 DisplayPort 1.4a ports

AMD Radeon RX6500, 4 GB, GDDR6

The following table lists the AMD Radeon RX6500 specifications.

Table 42. AMD Radeon RX6500 specifications

Feature	Values
Dedicated graphics memory	4 GB, GDDR6
Memory bus	64-bit
Memory config	SAMSUNG: K4ZAF325BM-HC16, DPN: 3PNGNHYNIX: H56G42AS4DX014, DPN MFN30
Width	Single slot
Approximate wattage	TBP: 51 W
Base clock	N/A
Boost clock	N/A
NVIDIA CUDA cores	N/A
G-Sync / Freesync ready	Freesync (AMD Interlock)
Supported APIs	DirectX 12 (AMD Interlock)
Maximum resolution	8K 120Hz, 8K@60Hz is the maximum resolution for one port config.
HDMI support	No
HDCP support	Yes
I/O ports	2 DisplayPort 1.4a ports

GPU and PSU matrix

The following table provides the GPU and PSU matrix of your OptiPlex Tower 7010.

Table 43. GPU and PSU matrix

GFx card	Card length	Weight (kg)	Power connector	I/O connector	Single/Dual wide	PSU
AMD Radeon RX6300	6.60 in.	0.138	NA	2 DisplayPort 1.4a ports	Single	180 W
AMD Radeon RX6500	6.60 in.	0.140	NA	2 DisplayPort 1.4a ports	Single	180 W

HDD Preloaded bracket and cable matrix

The following table lists the hard-disk drive preloaded bracket information of your OptiPlex Tower 7010.

Table 44. HDD Preloaded bracket and cable matrix

Hard drive Preloaded bracket	Available
3.5-inch Caddy/Bracket	No
2.5-inch Caddy/Bracket	No

Storage

2.5-inch, 1 TB, 5400 RPM, SATA, HDD

Table 45. 2.5-inch, 1 TB, 5400 RPM, SATA, HDD specifications

Description	Values		
Capacity	1 TB		
Speed	5400 RPM		
Height (approximate)	7.11 mm (0.28 in.)		
Width (approximate)	69.85 mm (2.75 in.)		
Depth (approximate)	100.58 mm (3.96 in.)		
Interface	SATA 3.0		
Speed (maximum)	Up to 6 Gbps		
MTBF	550,000 hours		
Logical blocks	1,953,525,168		
Power source	Power source		
Power consumption (reference only)	Idle: 0.7 W Active: 3.10 W		
Environmental operating conditions (non-condensing)			
Temperature range	5°C to 60°C		
Relative humidity range	5% to 90%		
Op shock	350G @2ms		
Environmental non-operating conditions (non-condensing)			
Temperature range	-40°C to 65°C		
Relative humidity range	5% to 95%		

2.5-inch, 2 TB, 5400 RPM, SATA, HDD

Table 46. 2.5-inch, 2 TB, 5400 RPM, SATA, HDD specifications

Description	Values	
Capacity	2 TB	
Speed	5400 RPM	
Height (approximate)	7.11 mm (0.28 in.)	
Width (approximate)	69.85 mm (2.75 in.)	
Depth (approximate)	100.58 mm (3.96 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	3,907,029,168	
Power source		

Table 46. 2.5-inch, 2 TB, 5400 RPM, SATA, HDD specifications (continued)

Description	Values	
Power consumption (reference only)	Idle: 0.7 WActive: 3.10 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	350G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

2.5-inch, 500 GB, 7200 RPM, SATA, HDD

Table 47. 2.5-inch, 500 GB, 7200 RPM, SATA, HDD specifications

Capacity	500 GB	
Speed	7200 RPM	
Height (approximate)	7.11 mm (0.28 in.)	
Width (approximate)	69.85 mm (2.75 in.)	
Depth (approximate)	100.58 mm (3.96 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	976,773,168	
Power source		
Power consumption (reference only)	• Idle: 0.7 W	
	• Active: 3.25 W	
Environmental operating conditions (non-condens	sing)	
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	350G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

2.5-inch, 1 TB, 7200 RPM, SATA, HDD

Table 48. 2.5-inch, 1 TB, 7200 RPM, SATA, HDD specifications

Capacity	1 TB
Speed	7200 RPM
Height (approximate)	7.11 mm (0.28 in.)

Table 48. 2.5-inch, 1 TB, 7200 RPM, SATA, HDD specifications (continued)

Width (approximate)	69.85 mm (2.75 in.)	
Depth (approximate)	100.58 mm (3.96 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	1,953,525,168	
Power source		
Power consumption (reference only)	• Idle: 0.7 W	
	Active: 3.25 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	350G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

2.5-inch, 500 GB, 7200 RPM, SATA, HDD, Self-Encrypting, Opal 2.0, FIPS

Table 49. 2.5-inch, 500 GB, 7200 RPM, SATA, HDD, Self-Encrypting, Opal 2.0, FIPS specifications

Capacity	500 GB	
Speed	7200 RPM OPAL SED FIPS	
Height (approximate)	7.11 mm (0.28 in.)	
Width (approximate)	69.85 mm (2.75 in.)	
Depth (approximate)	100.58 mm (3.96 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	976,773,168	
Power source		
Power consumption (reference only)	Idle: 0.7 WActive: 3.25 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	350G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	

Table 49. 2.5-inch, 500 GB, 7200 RPM, SATA, HDD, Self-Encrypting, Opal 2.0, FIPS specifications (continued)

Relative numidity range 5% to 95%	Relative humidity range	5% to 95%
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3.5-inch, 4 TB, 5400 RPM, SATA, HDD

Table 50. 3.5-inch, 4 TB, 5400 RPM, SATA, HDD specifications

Description	Values	
Capacity	4 TB	
Speed	5400 RPM	
Height (approximate)	25.40 mm (1.00 in.)	
Width (approximate)	147.06 mm (5.79 in.)	
Depth (approximate)	101.60 mm (4.00 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	7,814,037,168	
Power source		
Power consumption (reference only)	Idle: 5 W Active: 10 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	65G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

3.5-inch, 1 TB, 7200 RPM, SATA, HDD

Table 51. 3.5-inch, 1 TB, 7200 RPM, SATA, HDD specifications

Capacity	1 TB
Speed	7200 RPM
Height (approximate)	26.10 mm (1.02 in.)
Width (approximate)	147.06 mm (5.79 in.)
Depth (approximate)	101.60 mm (4.00 in.)
Interface	SATA 3.0
Speed (maximum)	Up to 6 Gbps
MTBF	550,000 hours
Logical blocks	1,953,525,168
Power source	

Table 51. 3.5-inch, 1 TB, 7200 RPM, SATA, HDD specifications (continued)

Power consumption (reference only)	Idle: 5 WActive: 10 W
Environmental operating conditions (non-condensing)	
Temperature range	5°C to 60°C
Relative humidity range	5% to 90%
Op shock	65G @2ms
Environmental non-operating conditions (non-condensing)	
Temperature range	-40°C to 65°C
Relative humidity range	5% to 95%

3.5-inch, 2 TB, 7200 RPM, SATA, HDD

Table 52. 3.5-inch, 2 TB, 7200 RPM, SATA, HDD specifications

Description	Values	
Capacity	2 TB	
Speed	7200 RPM	
Height (approximate)	25.40 mm (1.00 in.)	
Width (approximate)	147.06 mm (5.79 in.)	
Depth (approximate)	101.60 mm (4.00 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	3,907,029,168	
Power source		
Power consumption (reference only)	• Idle: 5 W	
	Active: 10 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	65G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

M.2 2230, 512 GB, PCIe NVMe, Class 25 SSD

The following table lists the M.2 2230, 512 GB SSD specifications.

Table 53. 512 GB SSD specifications

Description	Values
Capacity	512 GB

Table 53. 512 GB SSD specifications (continued)

Description	Values	
Height (approximate)	3.50 mm (0.17 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	30.00 mm (1.18 in.)	
Interface type	PCle	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	1,000,215,216	
Power source		
Power consumption (reference only)	• Idle: 5 mW (PS4)	
	Active: 3.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2230, 1 TB, PCIe NVMe, Class 25 SSD

The following table lists the M.2 2230, 1 TB SSD specifications.

Table 54. 1 TB SSD specifications

Capacity	1 TB	
Height (approximate)	3.50 mm (0.17 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	30.00 mm (1.18 in.)	
Interface type	PCle	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	2,000,409,264	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4) Active: 3.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock 1500G		
Environmental non-operating conditions (non-condensing)		

Table 54. 1 TB SSD specifications (continued)

Temperature range	-40°C to 70°C
Relative humidity range	5% to 95%

M.2 2230, 256 GB, PCIe NVMe, Class 35 SSD

The following table lists the M.2 2230, 256 GB SSD specifications.

Table 55. 256 GB SSD specifications

Capacity	256 GB	
Height (approximate)	3.50 mm (0.17 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	30.00 mm (1.18 in.)	
Interface type	PCle	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	500,118,192	
Power source		
Power consumption (reference only)	• Idle: 5 mW (PS4)	
	• Active: 3.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2230, 512 GB, PCIe NVMe, Class 35 SSD

The following table lists the M.2 2230, 512 GB SSD specifications.

Table 56. 512 GB SSD specifications

Capacity	512 GB
Capacity	312 GD
Height (approximate)	3.50 mm (0.17 in.)
Width (approximate)	22.00 mm (0.87 in.)
Depth (approximate)	30.00 mm (1.18 in.)
Interface type	PCle
Speed (maximum)	32 Gb/s (up to 4 lanes)
MTBF	1.4M hours
Logical blocks	1,000,215,216
Power source	

Table 56. 512 GB SSD specifications (continued)

Power consumption (reference only)	Idle: 5 mW (PS4)Active: 3.50 W
Environmental operating conditions (non-condensing)	
Temperature range	0°C to 70°C
Relative humidity range	10% to 90%
Op shock	1500G
Environmental non-operating conditions (non-condensing)	
Temperature range	-40°C to 70°C
Relative humidity range	5% to 95%

M.2 2230, 1 TB, PCIe NVMe, Class 35 SSD

The following table lists the M.2 2230, 1 TB SSD specifications.

Table 57. 1 TB SSD specifications

· · · · · · · · · · · · · · · · · · ·		
Capacity	1 TB	
Height (approximate)	3.50 mm (0.17 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	30.00 mm (1.18 in.)	
Interface type	PCle	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	2,000,409,264	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4)Active: 3.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2230, 256 GB, PCIe NVMe, Opal Self-Encrypting Class 35 SSD

The following table lists the M.2 2230, 256 GB SSD, self-encrypting drive specifications.

Table 58. 256 GB SSD, self-encrypting drive specifications

Capacity	256 GB
Height (approximate)	3.50 mm (0.17 in.)

Table 58. 256 GB SSD, self-encrypting drive specifications (continued)

Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	30.00 mm (1.18 in.)	
Interface type	PCle	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	500,118,192	
Power source		
Power consumption (reference only)	• Idle: 5 mW (PS4)	
	Active: 3.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2280, 512 GB, PCIe NVMe, Class 40 SSD, self-encrypting drive

The following table lists the M.2 2280, 512 GB SSD, self-encrypting drive specifications

Table 59. 512 GB SSD, self-encrypting drive specifications

Capacity	512 GB	
Height (approximate)	3.50 mm (0.17 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	80.00 mm (3.15 in.)	
Interface type	PCle	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	1,000,215,216	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4 - L1.2)Active: 4.50 W	
Environmental operating conditions (non-condensing)		
Temperature range 0°C to 70°C		
Relative humidity range	10% to 90%	
Op shock 1500G		
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2280, 1 TB, PCIe NVMe, Class 40 SSD, self-encrypting drive

The following table lists the M.2 2280, 1 TB SSD, self-encrypting drive specifications

Table 60. 1 TB SSD, self-encrypting drive specifications

Capacity	1 TB	
Height (approximate)	3.50 mm (0.17 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	80.00 mm (3.15 in.)	
Interface type	PCle	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	2,000,409,264	
Power source		
Power consumption (reference only)	• Idle: 5 mW (PS4 - L1.2)	
	Active: 4.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2280, 512 GB, PCIe NVMe, Class 40 SSD

The following table lists the M.2 2280, 512 GB SSD specifications.

Table 61. 512 GB SSD specifications

Capacity	512 GB	
Height (approximate)	3.50 mm (0.17 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	80.00 mm (3.15 in.)	
Interface type	PCle	
Speed (maximum)	64 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	1,000,215,216	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4 - L1.2)Active: 5 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	

Table 61. 512 GB SSD specifications (continued)

Relative humidity range	10% to 90%		
Op shock	1500G		
Environmental non-operating conditions (non-condensing)			
Temperature range -40°C to 70°C			
Relative humidity range	5% to 95%		

M.2 2280, 1 TB, PCIe NVMe, Class 40 SSD

The following table lists the M.2 2280, 1 TB SSD specifications.

Table 62. 1 TB SSD specifications

Capacity	1 TB	
Height (approximate)	3.50 mm (0.17 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	80.00 mm (3.15 in.)	
Interface type	PCle	
Speed (maximum)	64 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	2,000,409,264	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4 - L1.2)Active: 5 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2280, 2 TB, PCIe NVMe, Class 40 SSD

The following table lists the M.2 2280, 2 TB SSD specifications.

Table 63. 2 TB SSD specifications

Capacity	2 TB	
Height (approximate)	3.50 mm (0.17 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	80.00 mm (3.15 in.)	
Interface type	PCle	
Speed (maximum)	64 Gb/s (up to 4 lanes)	

Table 63. 2 TB SSD specifications (continued)

MTBF	1.4M hours	
Logical blocks	4,000,797,360	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4 - L1.2)Active: 5 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

8x DVD±RW, slimline

Table 64. 8x DVD±RW, slimline specifications

Height (without bezel)	9.50 mm (0.37 in.)		
Width (without bezel)	128.00 mm (5.04 in.)		
Depth (without bezel)	126.01 mm (4.97 in.)		
Weight (maximum)	140 grams		
Interface	SATA 1.5		
Speed (maximum)	Up to 1.5 Gbps		
Disc capacity	Standard		
Internal buffer size	0.5 MB		
Access times (typical)	Supplier dependent		
Maximum data transfer rates			
Writes	8x DVD/ 24x CD		
Reads	8x DVD/ 24x CD		
Power source			
DC power requirements 5 V			
DC current	1300 mA		
Environmental operating conditions (non-condensing)			
Operating temperature range	5°C to 60°C		
Relative humidity range	10% to 90% RH		
Maximum wet bulb temperature	29°C		
Altitude range	0 m to 3048 m		
Environmental non-operating conditions (non-condensing)			
Operating temperature range	-40°C to 65°C		
Relative humidity range	5% to 95% RH		

Table 64. 8x DVD±RW, slimline specifications (continued)

Maximum wet bulb temperature	38°C
Altitude range	0 m to 10600 m

Power

NOTE: The form factor utilizes a more efficient Active Power Factor Correction (APFC) power supply. Dell recommends only Universal Power Supplies (UPS) based on Sine Wave output for APFC PSUs, not an approximation of a Sine Wave, Square Wave, or quasi-Square Wave. If you have questions, please contact the manufacturer to confirm the output type. Offering and availability may vary by region.

Table 65. OptiPlex Tower 7010 - Power supply unit specifications

Description	Values		
Туре	180 W (80 PLUS Bronze)	300 W (80 PLUS Platinum)	
Erp Lot6 Tier 2 requirement	Yes	Yes	
80 Plus compliant	Yes	Yes	
Energy Star 8.0 compliant	Yes	Yes	
GS mark compliant	Yes	Yes	
FEMP Standby Power Compliant	Yes	Yes	

Thermal dissipation

The following table lists the thermal dissipation of your OptiPlex Tower 7010.

Table 66. Thermal dissipation

Power supply unit	Heat dissipation	Voltage
180 W (80 Plus Bronze)	180*3.412=614 BTU/hr	100 to 240 VAC, 50 to 60 Hz, 3.0 A/1.5 A
300 W (80 Plus Platinum)	300*3.412=1023 BTU/hr	100 to 240 VAC, 50 to 60 Hz, 4.2 A/2.1 A

CMOS battery

The following table lists the CMOS battery specifications of your OptiPlex Tower 7010.

Table 67. CMOS battery

Brand	Туре	Voltage	Composition	Battery life
MITSUBISHI	CR2032	3.0 V	Lithium metal	Continuous Discharge Under 15 kΩ Load to 2.0 V End-Voltage. 20°C±2°C 940 Hrs. or Longer.910 Hrs.or Longer after 12 mo.

Accessories

The following table lists the supported accessories on your OptiPlex Tower 7010.

Table 68. Accessories

Accessories	
Dell Pro Webcam - WB5023	
Dell Slim Conferencing Soundbar - SB522A	
Dell Pro Stereo Headset - WH3022	
Dell 24 Monitor - P2422H	
Dell UltraSharp 24 Monitor - U2422H	
Dell Pro Wireless Keyboard and Mouse (White) - KM5221W	
OptiPlex MT Cable Cover	

Security

Software security

The following table lists the software security details of your OptiPlex Tower 7010.

Trusted Platform Module

The following table lists the Trusted Platform Module (TPM) of your OptiPlex Tower 7010.

Table 69. Trusted Platform Module (TPM)

TPM: Nuvoton NPCT760JABYX	
SPI interface	
TPM 2.0	
FIPs 140-2 certificate	

Mil-SPEC

The OptiPlex Tower 7010 meets military specifications for the following MIL-STD 810H tests:

Table 70. Tower - Military specifications

Test Category	Test Method	Test Parameters
Altitude Storage Transport	Method 500.6 Procedure I	 Test Pressure: Equivalent to cabin altitude of 15,000ft Temperature: 21°C; Altitude Change Rate: <10 m/s Duration: 1 hour Unit is non-operational during test.

Table 70. Tower - Military specifications (continued)

Test Category	Test Method	Test Parameters
Altitude Operation/ Air Carriage	Method 500.6 Procedure II	 Test Pressure: Equivalent to cabin altitude of 15,000 ft Temperature: 21°C; Altitude Change Rate: <10 m/s Duration: 1 hour Unit is operational during test.
Low Temperature (Exaggerated)	Method 502.7 Procedure I	 Duration: 24 hour exposure Temperature: -51 °C Unit is operational during test
Low Temperature	Method 502.7 Procedure II	 Duration: 24 hour exposure Temperature: -29 °C Unit is operational during test
Humidity Induced (Storage &Transit) and Naturaland Cycles	Method 507.6 Procedure I	 Duration: Refer to MIL-spec Table 507.6-II Non-hazardous test items.
Vibration Operational	Method 514.8Procedur e I -Category 4	 Operational Vibration, 10-500 Hz, 1.04 Grms, random 1 hour on Bottom, Left and Back side. Unit is operational during test.
Shock Material to be Packaged	Method 516.8 Procedure II	 On-road Shock, 5.1g / 11ms (Table 516-8-VII) Off-road Shocks 15.2g / 5ms (Table 516-8-VII) Test unit orientations at x, y and z axis for both test. Unit is non-operational during both test
Bench Handling	Method 516.8 Procedure VI	 Angle drops onto solid wooden bench thickness least 4.25cm(1.675 inch). Test height judgement as two conditions arise test units at one edge 100 mm (4 inch) or rise an angle of 45° about a solid wooden bench top. Unit is non-operational during test.
Sand and Dust Blowing Dust	Method 510.7 Procedure I	 Duration: 12 hours Air velocity = 1.5 m/s (300 ft/min) to 8.9 m/s (1750 ft/min) Temperature: 60 °C Relative Humidity: 30% 6H at standard ambient temperature and 6 hours at the high storage or operating temperature Unit is non-operational during test.
Crash Hazard ShockTest	Method 516.8 Procedure V	 185g, 2 ms Half Sine 2 shocks/axis/ direction for a total of 12 shocks. Unit is non-operational during test.
Functional Shock	Method 516.8Procedur e I	 185g, 2 ms Half Sine 1 shock/axis/ direction for a total of 6 shocks Unit is operational during test.

Acoustic noise emission information tower

The following table lists the acoustic noise emission information of your OptiPlex Tower 7010.

Table 71. Acoustic noise emission information tower

Component	Test Configuration
CPU	15-13600
Memory	64 GB
HDD (#, capacity)	1 TB Solid-state drive
ODD	No
Graphics Adapter	UMA

Table 72. Declared Sound Power (LWAd)

Operating Mode	Declared Sound Power(LWAd)
Idle	2.9
HDD Operating	2.8
CPU Stressed	3.1
ODD Operating	3.5

Table 73. A-Weighted Sound Pressure Level (dB)

Declared Sound Pressure (LpA)			
	Tabletop System	Tabletop System	
Operating Mode	Operator Position	Bystander Position	
Idle	21.4	17.7	
HDD Operating	21.1	17.7	
CPU Stressed	25	19.8	
ODD Operating	29	21.1	

All tests are conducted according to ISO 7779 and declared according to ISO 9296 except CPU Stressed. This test mode is not specified in ISO 7779, but was measured using the same microphone distances and measurement techniques defined for the other reported operating modes.

Declared Sound Power rounded to nearest tenth of a bel per ISO 9296 section 4.4.2

Chassis enclosure and ventilation requirements

Enclosure ventilation

If your enclosure has doors, they need to be of a type that allows at least 30% airflow through the enclosure (front and back).

Enclosure minimum clearance

Leave a 10.2 cm (4 in.) minimum clearance on all vented sides of the computer to permit the airflow required for proper ventilation.

Recommended enclosure

Do not install your computer in an enclosure that does not allow airflow/dusty environment/temperate over 35°C. Do not put any objects to directly block air-vent. This restricts the airflow and impacts your computer's performance, possibly causing it to overheat.

Open desk minimum clearance

If your computer is installed in a corner, on a desk, or under a desk, leave at least 5.1 cm (2 in.) clearance from the back of the computer to the wall to permit the airflow required for proper ventilation.

System management features

Dell commercial systems come with a number of systems management options that are include by default for In-Band management with our Dell Client Command Suite. In-Band management meaning that the Operating System is functional and the device is connected to a network so that it can be managed. The Dell Client Command Suite of tools can be leveraged individually or with a systems management console like SCCM, LANDESK, KACE, etc.

We also offer Out-of-Band management as an option. Out-of-band management is when the system does not have a functional operating system or is turned off and you still want to be able to manage the system in that state.

Dell Client Command Suite for In-Band systems management

Dell Client Command Suite is a free toolkit available for download, for all Latitude Rugged tablets at dell.com/support, that automates and streamlines systems management tasks, saving time, money, and resources. It consists of the following modules that can be used independently, or with a variety of systems management consoles such as SCCM.

Dell Client Command Suite's integration with VMware Workspace ONE Powered by AirWatch, now allows customers to manage their Dell client hardware from the cloud, using a single Workspace ONE console.

Dell Command | Deploy enables easy operating system (OS) deployment across all major OS deployment methodologies and provides numerous system-specific drivers that have been extracted and reduced to an OS-consumable state.

Dell Command I Configure is a graphical user interface (GUI) admin tool for configuring and deploying hardware settings in a pre-OS or post-OS environment, and it operates seamlessly with SCCM and Airwatch and can be self-integrated into LANDesk and KACE. Simply, this is all about the BIOS. Command I Configure allows you to remotely automate and configure over 150+BIOS settings for a personalized user experience.

Dell Command I PowerShell Provider can do the same things as Command I Configure, but with a different method. PowerShell is a scripting language that allows customers to create a customized and dynamic configuration process.

Dell Command I Monitor is a Windows Management Instrumentation (WMI) agent that provides IT admins with an extensive inventory of the hardware and health-state data. Admins can also configure hardware remotely by using command line and scripting.

Dell Command | Update (end-user tool) is factory-installed and allows admins to individually manage and automatically present and install Dell updates to the BIOS, drivers, and software. Command I Update eliminates the time-consuming hunting and pecking process of update installation.

Dell Command I Update Catalog provides searchable metadata that allows the management console to retrieve the latest system-specific updates (driver, firmware or BIOS). The updates are then delivered seamlessly to end-users using the customer's systems management infrastructure that is consuming the catalog (like SCCM).

Dell Command | vPro Out of Band console extends hardware management to systems that are offline or have an unreachable OS (Dell exclusive features).

Dell Command | Integration Suite for System Center - This suite integrates all the key components of the Client Command Suite into Microsoft System Center Configuration Manager 2012 and Current Branch versions.

Out of Band Systems Management

Intel Standard Manageability option **must be configured in our factory at the time of purchase, as it is NOT field upgradable.** It offers out-of-band management and DASH compliance (https://registry.dmtf.org/registry/results/field_initiative_name%3A%22DASH%201.0%22).

Intel vPro provides an enhanced level of built-in security, hardware-level security and comprehensive cyber defense. Intel vPro allows you to remotely power on devices, streamline PC life cycle management without compromising productivity, secure, repair, and maintain when needed.

Systems that are configured with Intel Core processors support Intel . Check the processor specifications section for the list of Intel ν Pro enabled processors.

Getting help and contacting Dell

Self-help resources

You can get information and help on Dell products and services using these self-help resources:

Table 74. Self-help resources

Self-help resources	Resource location	
Information about Dell products and services	www.dell.com	
My Dell app	DELL	
Tips	*	
Contact Support	In Windows search, type Contact Support, and press Enter.	
Online help for operating system	www.dell.com/support/windows	
	www.dell.com/support/linux	
Access top solutions, diagnostics, drivers and downloads, and learn more about your computer through videos, manuals, and documents.		
Dell knowledge base articles for a variety of computer concerns	 Go to www.dell.com/support. On the menu bar at the top of the Support page, select Support > Knowledge Base. In the Search field on the Knowledge Base page, type the keyword, topic, or model number, and then click or tap the search icon to view the related articles. 	

Contacting Dell

To contact Dell for sales, technical support, or customer service issues, see www.dell.com/contactdell.

- (i) NOTE: Availability varies by country/region and product, and some services may not be available in your country/region.
- NOTE: If you do not have an active Internet connection, you can find contact information about your purchase invoice, packing slip, bill, or Dell product catalog.